

CYStech Electronics Corp.

Spec. No. : C763LD Issued Date : 2009.05.15

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5.0Amp Schottky Barrier Rectifiers Reverse Voltage 100V Forward Current 5A

SB5100

Features

- Guard ring for over voltage protection.
- Plastic package has UL flammability classification 94V-0
- Low power loss, high efficiency
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Mechanical Data

• Case: JEDEC DO-201AD molded plastic body

• Epoxy: UL94V-0 rate flame retardant

• Terminals: Plated axial leads, solderable per MIL-STD-750 method

2026. High temperature soldering guaranteed: 250°C/10seconds, 0.375"(9.5mm) lead length, 5lbs(2.3kg)

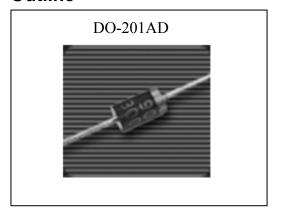
tension

• Polarity: Color band denotes cathode end.

• Mounting Position : Any.

• Weight: 0.041 oz., 1.15 gram

Outline



Maximum Ratings and Electrical Characteristics

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%)

Parameter	Symbol	Type SB5100	Units	
Maximum repetitive peak reverse v	Vrrm	100	V	
Maximum RMS voltage	Vrms	70	V	
Maximum DC blocking voltage	V _{DC}	100	V	
Maximum instantaneous forward vo	V_{F}	0.85	V	
Maximum average forward rectified lead length (see Fig 1)	IF(AV)	5	A	
Peak forward surge current @8.3ms superimposed on rated load (JEDEC	Ifsm	150	A	
Maximum DC reverse current at	TA=25°C	I.	0.5	A
rated DC blocking voltage ¹	Ta=100°C	$ I_R$	50	— mA
Typical thermal resistance ²	RөлL	10	°C/W	
Operating junction temperature rang	Тл	-55 ~ +125	$^{\circ}\mathbb{C}$	
Storage temperature range	Tstg	- 55 ∼ +150	$^{\circ}\!\mathbb{C}$	

Note: 1.Pulse test: pulse width≤300µs, duty cycle≤1%

2. Thermal resistance, junction to lead, vertical PCB mounted, 0.375"(9.5mm) lead length



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Characteristic Curves

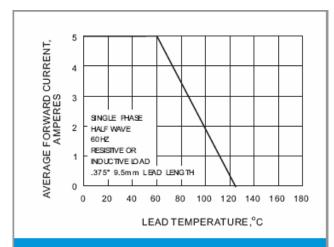


Fig. 1- FORWARD CURRENT DERATING CURVE

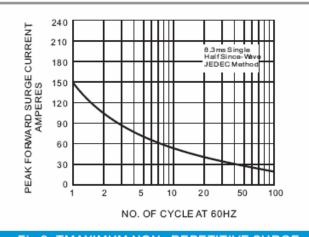
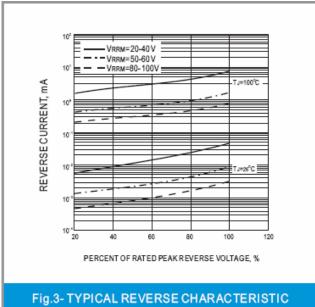


Fig.2-TMAXIMUM NON-REPETITIVE SURGE CURRENT



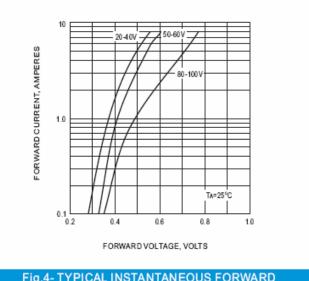


Fig.4- TYPICAL INSTANTANEOUS FORWARD **CHRACTERISTIC**

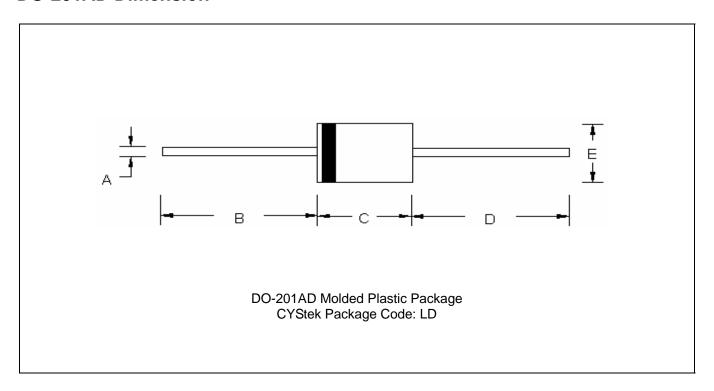


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DO-201AD Dimension



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.	וווט	Min.	Max.	Min.	Max.
Α	φ0.048	φ0.052	φ1.20	φ1.30	D	1.000	-	25.40	-
В	1.000	-	25.40	-	Е	φ0.190	φ0.210	φ4.80	φ5.30
С	0.285	0.375	7.20	9.50					·

Notes: 1.Controlling dimension: millimeters.

2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material. 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead : Axial leads, solderable per MIL-STD-750, Method 2026 guaranteed.
- Mold Compound : Epoxy resin family, flammability solid burning class: UL94V-0

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